

HTM® 60

Epoxy; Epoxide

Cytec Industries Inc.

Message:

HTM® 60 is a 180°C (356°F) curing epoxy matrix resin developed for component manufacture where very high temperature resistance is required. After suitable post-cure, HTM60 offers a maximum Tg of 230°C (446°F) and retains a Tg of 155°C (311°F) under wet conditions.

HTM60 will adhere to Nomex honeycomb without the need for an additional adhesive film.

HTM60 is particularly suitable for high temperature structural and bodywork applications in the motorsport industry.

General Information		
Features	Good Adhesion	
	Heat Cure	
	High Heat Resistance	
Uses	Automotive Applications	
	Structural Parts	
Physical	Nominal Value	Unit
Specific Gravity ¹	1.29	g/cm ³
NOTE		
1.	Cured resin	

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Recommended distributors for this material

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